

1.6 x 1.5 x 0.6mm Red & Yellow Chip LED

OSRY0603C1C

■Features

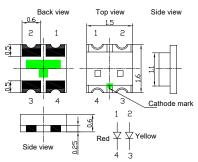
- Bi-color chip LED
- Super high brightness of surface mount LED
- Water clear flat mold
- Compact package outline (LxWxT) of 1.6mm x 1.5mm x 0.6mm
- Compatible to reflow soldering.

Applications

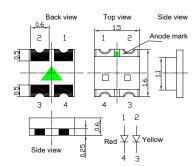
- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)

■Outline Dimension

OR



Notes: 1. All dimensions are in millimeters; 2. Tolerance is @ 0.10 m m unless otherwise

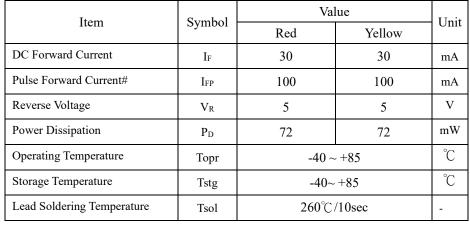


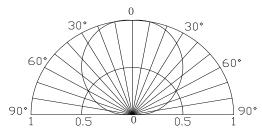
Notes: 1. All dimensions are in millimeters ; 2. Tolerance is @ 0.10 mm unless otherwise noted

■Absolute Maximum Rating

(Ta=25°C)

Directivity





#Pulse width Max 0.1ms, Duty ratio max 1/10

■Electrical -Optical Characteristics

$(Ta=25^{\circ}C)$

| | Color | | $V_{F}(V)$ | | | $I_R(\mu A)$ | Iv(mcd) | | | λD(nm) | | | 2θ1/2(deg) |
|-------------|--------|--|---------------------|------|------|--------------------|---------------------|------|------|--------|------|------|------------|
| Part Number | | | Min. | Тур. | Max. | Max. | Min. | Тур. | Max. | Min. | Тур. | Max. | Тур. |
| | | | I _F =5mA | | | V _R =5V | I _F =5mA | | | | | | |
| OSRY0603C1C | Red | | - | 2.0 | 2.4 | 10 | 25 | 40 | - | 620 | 625 | 630 | 120 |
| | Yellow | | - | 2.0 | 2.4 | 10 | 25 | 40 | - | 585 | 590 | 595 | 120 |

^{*1} Tolerance of measurements of dominant wavelength is ±1nm









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^{*2} Tolerance of measurements of luminous intensity is ±15%

^{*3} Tolerance of measurements of forward voltage is±0.1V



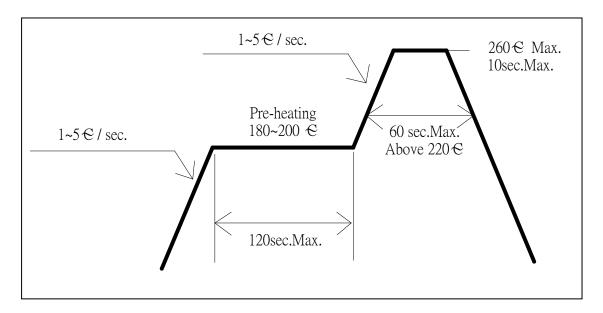
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■ Soldering Conditions

| | Reflow Soldering | Hand Soldering | | | |
|------------------|------------------------------|----------------|-----------------|--|--|
| Pre-Heat | 180 ~ 200°C | | | | |
| Pre-Heat Time | 120 sec. Max. | | | | |
| Peak Temperature | 260°C Max. | Temperature | 350°C Max. | | |
| Dipping Time | 10 sec. Max. | Soldering time | 3 sec. Max. | | |
| Condition | Refer to Temperature-profile | | (one time only) | | |

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

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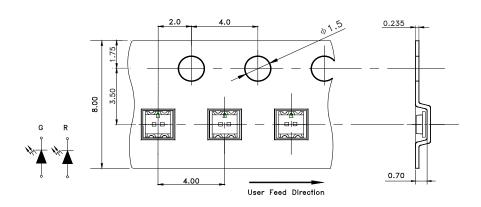


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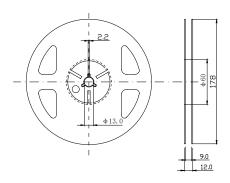


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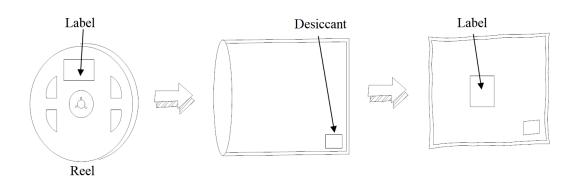
■ Reel & Tape Dimensions (4000pcs/reel)



■Reel Dimensions



■Moisture Resistant Packaging



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■ Cautions:

- 1. After open the package, the LED´s floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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